2SD2121(L)/(S)

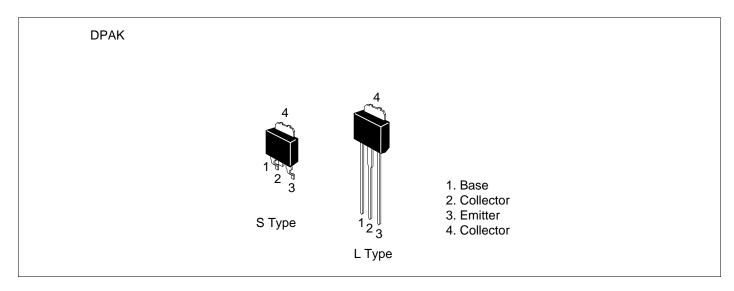
Silicon NPN Epitaxial

HITACHI

Application

Low frequency power amplifier complementary pair with 2SB1407(L)/(S)

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	35	V
Collector to emitter voltage	V _{CEO}	35	V
Emitter to base voltage	V_{EBO}	5	V
Collector current	I _c	2.5	A
Collector peak current	C(peak)	3	A
Collector power dissipation	P _c *1	18	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at $T_c = 25$ °C.



2SD2121(L)/(S)

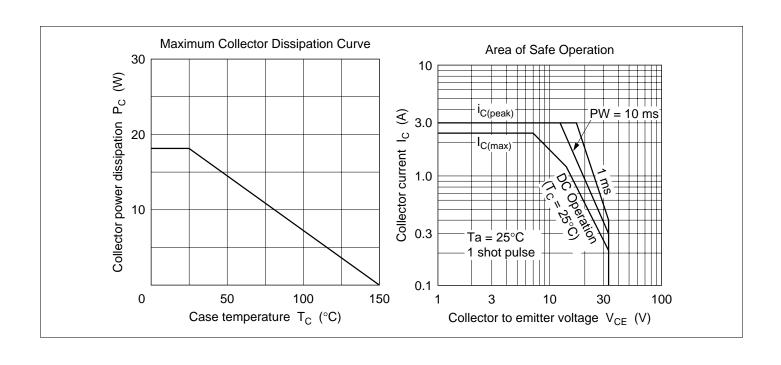
$\textbf{Electrical Characteristics} \; (Ta = 25^{\circ}C)$

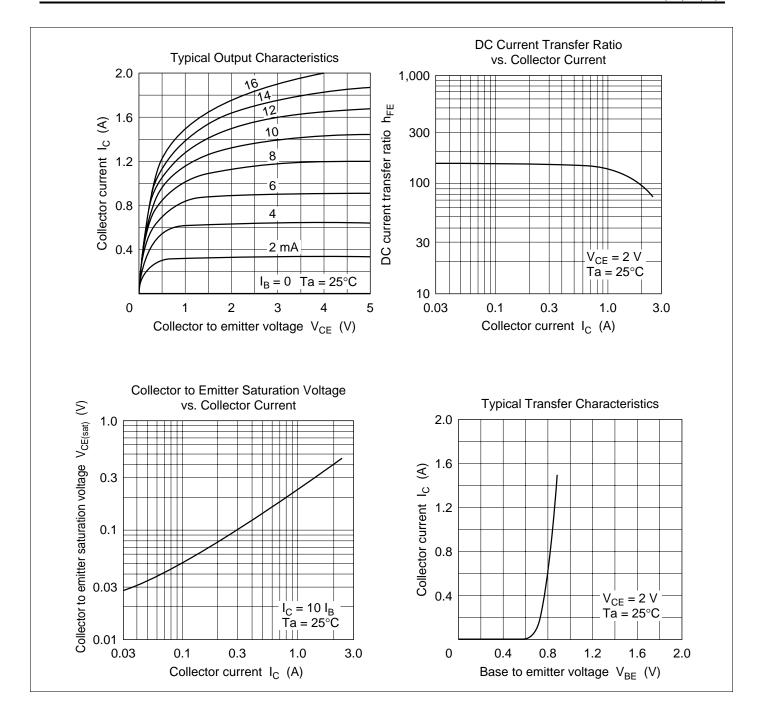
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	35	_	_	V	$I_C = 1 \text{ mA}, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	35	_	_	V	$I_{\rm C}$ = 10 mA, $R_{\rm BE}$ = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_E = 1 \text{ mA}, I_C = 0$
Collector cutoff current	I _{CBO}			20	μΑ	$V_{CB} = 35 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1} *1	60	_	320		$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}^{*2}$
	h _{FE2}	20		_		$V_{CE} = 2 \text{ V}, I_{C} = 1.5 \text{ A}^{*2}$
Base to emitter voltage	V_{BE}		_	1.5	V	$V_{CE} = 2 \text{ V}, I_{C} = 1.5 \text{ A}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0	V	$I_{\rm C} = 2 \text{ A}, I_{\rm B} = 0.2 \text{ A}^{*2}$

Notes: 1. The 2SD2121(L)/(S) is grouped by h_{FE1} as follows.

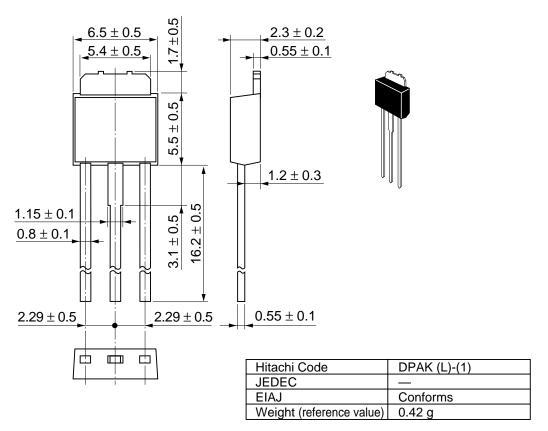
В	С	D
60 to 120	100 to 200	160 to 320

2. Pulse test.





Unit: mm



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